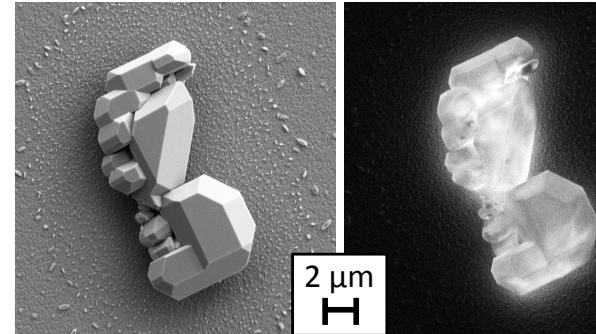
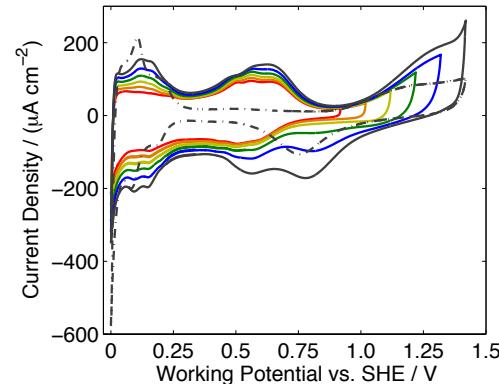
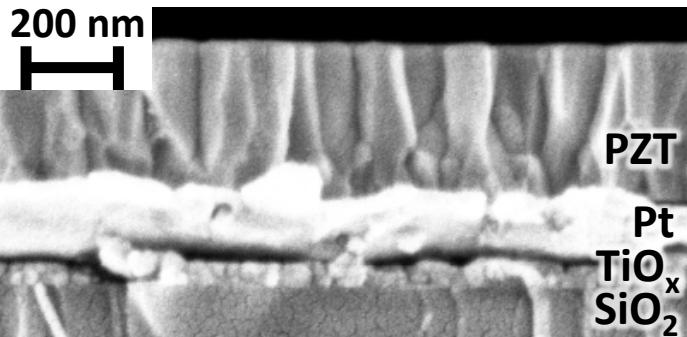


Exceptional service in the national interest



Degradation of Thin Film $\text{Pb}(\text{Zr},\text{Ti})\text{O}_3$ in H_2SO_4

Leo Small¹, Chris Applett¹, Geoff Brennecka¹, Jon Ihlefeld¹, David Duquette²

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²Dept. of Materials Science, Rensselaer Polytechnic Institute, Troy, NY



Sandia National Laboratories is a multi-program laboratory managed and operated by Sandia Corporation, a wholly owned subsidiary of Lockheed Martin Corporation, for the U.S. Department of Energy's National Nuclear Security Administration under contract DE-AC04-94AL85000. SAND NO. 2011-XXXXP

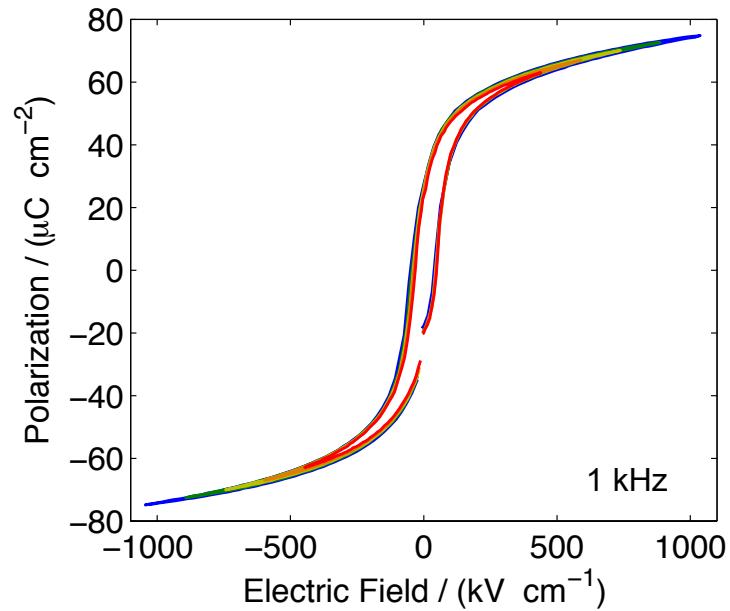
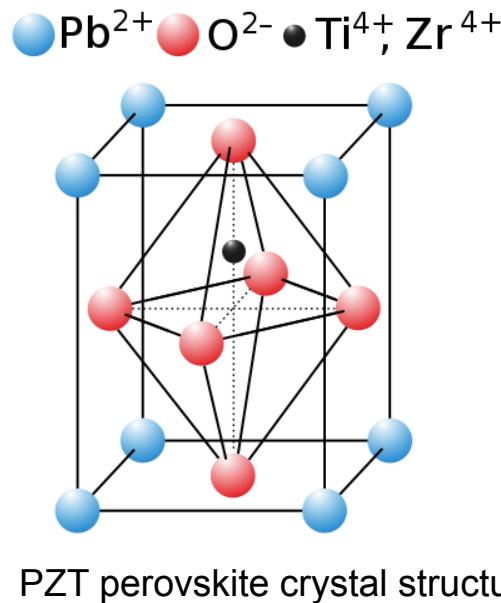
PZT in H_2SO_4 : Motivation

- **Remote, self-powered sensors for extreme environments**
- Chemical processing plants, down-hole oil wells
- High pressure, high temperature, low pH: no wires!

How does PZT interact with acidic,
aqueous environments?

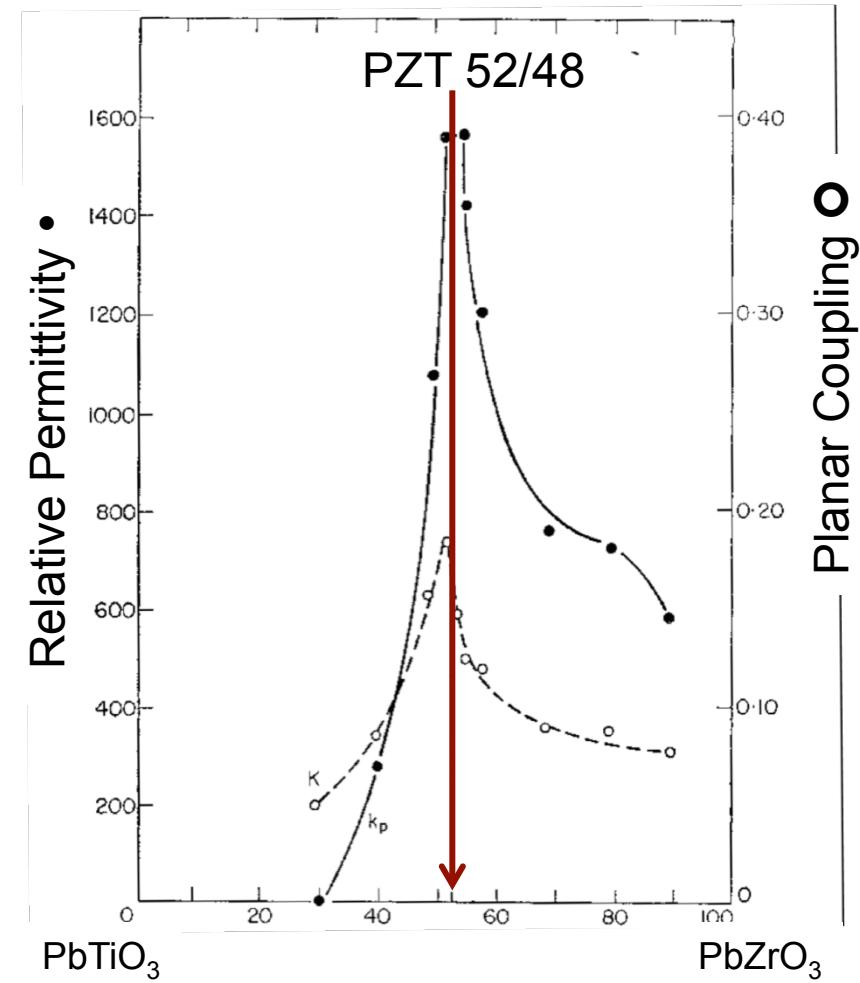
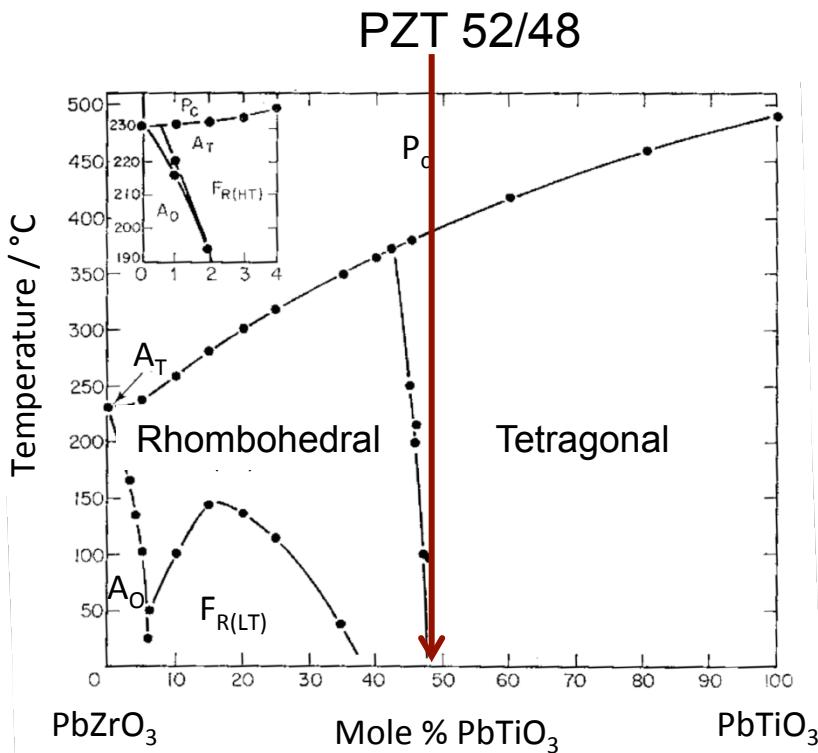
$\text{PbZr}_{0.52}\text{Ti}_{0.48}\text{O}_3$

- Ferroelectrics possess a reversible, thermodynamically stable surface charge.

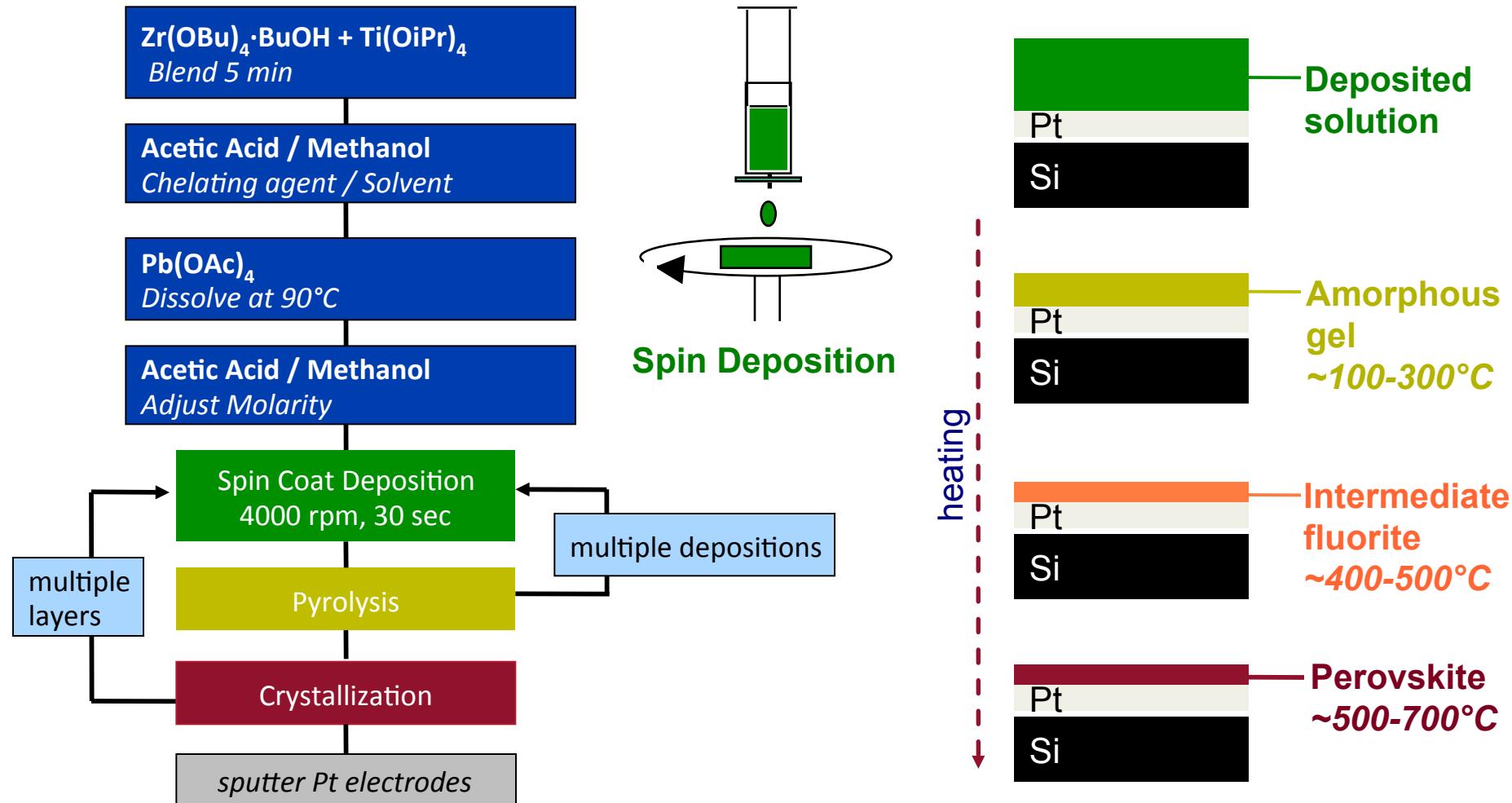


Why $\text{PbZr}_{0.52}\text{Ti}_{0.48}\text{O}_3$?

- Morphotropic phase boundary
- Increased piezoelectric performance

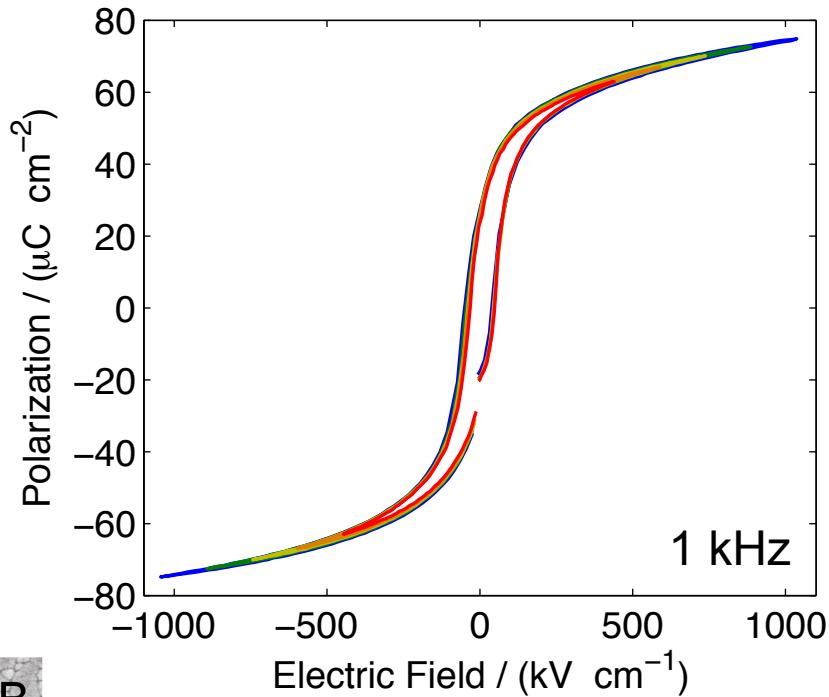
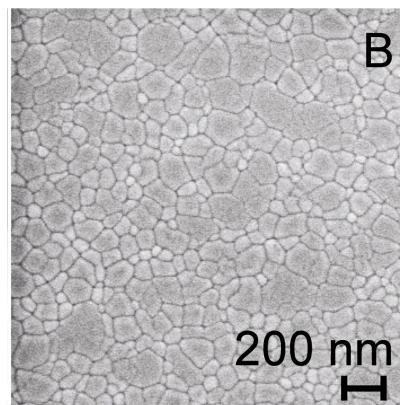
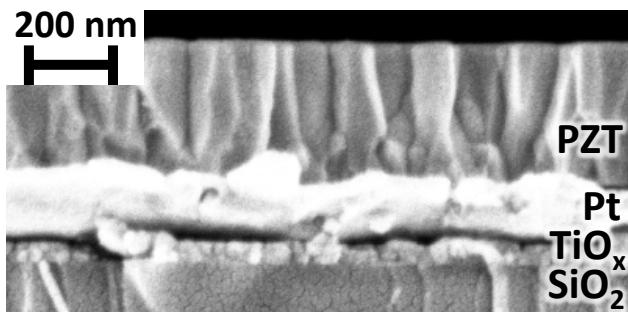


SNL Chemical Solution Deposition



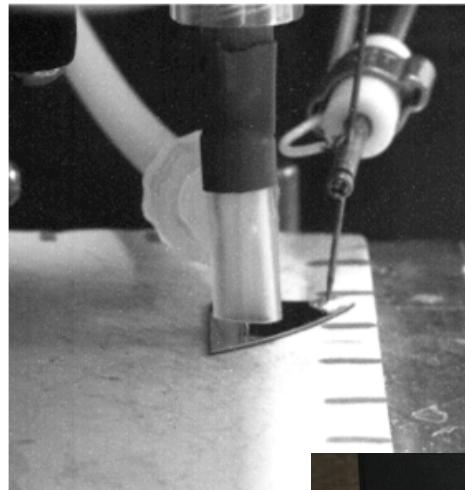
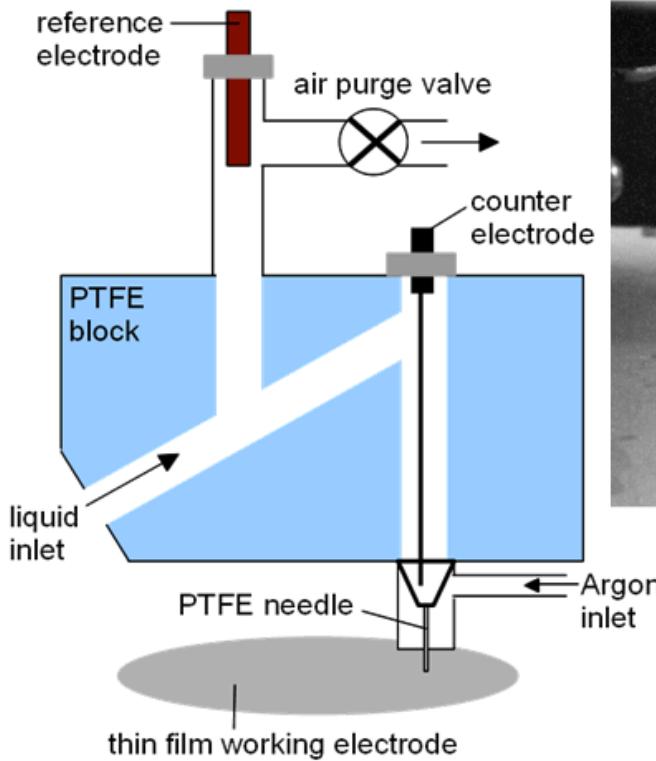
Sol-Gel PZT

- Dense columnar microstructure
- Random orientation
- Zero bias relative permittivity ~ 1200
- Resistivity: $10^{13} \Omega \cdot \text{cm}$ at 1.5 V
- Remanent polarization: $32 \mu\text{C}/\text{cm}^2$

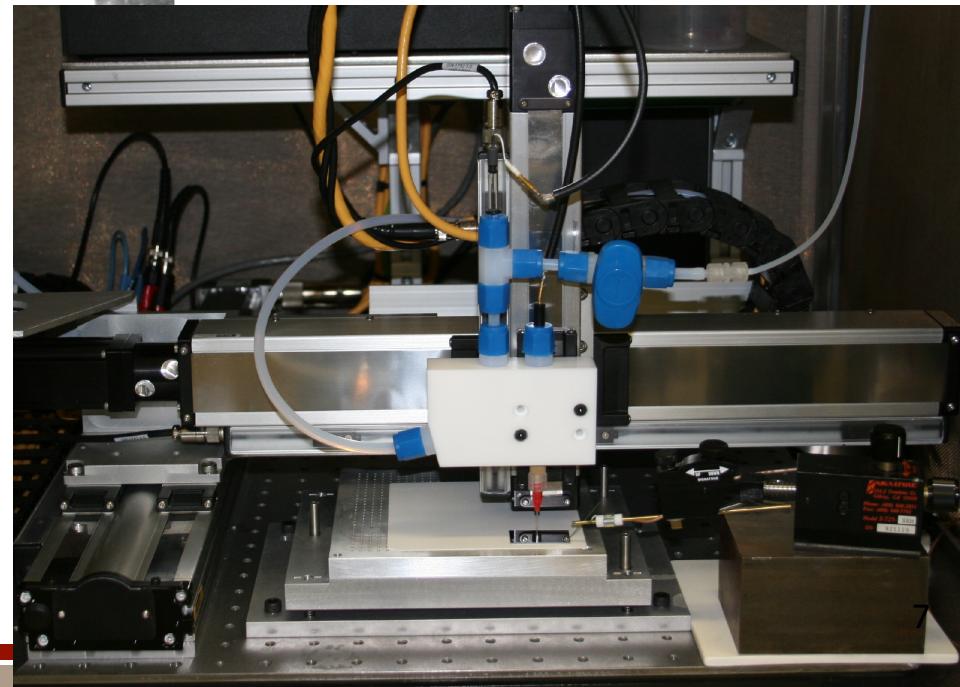


(A) Cross sectional and
(B) Plan-view SEM images

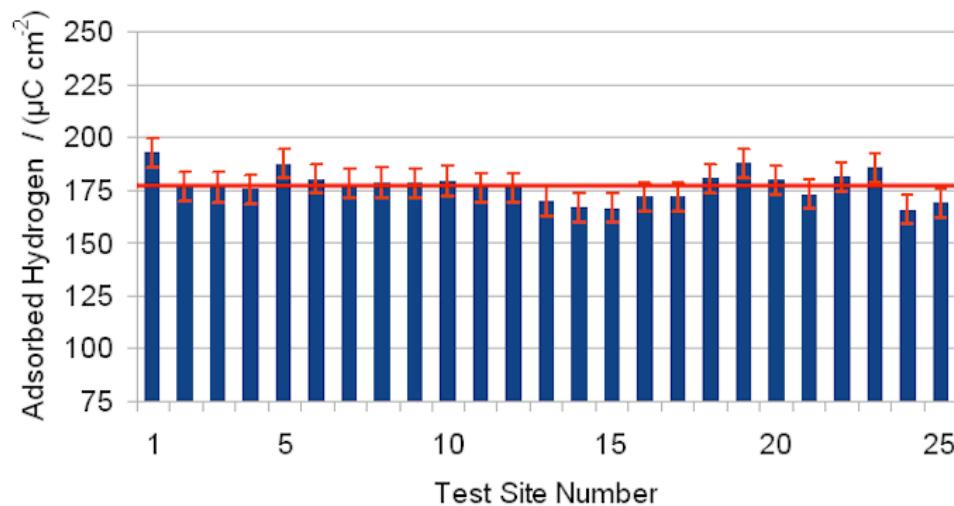
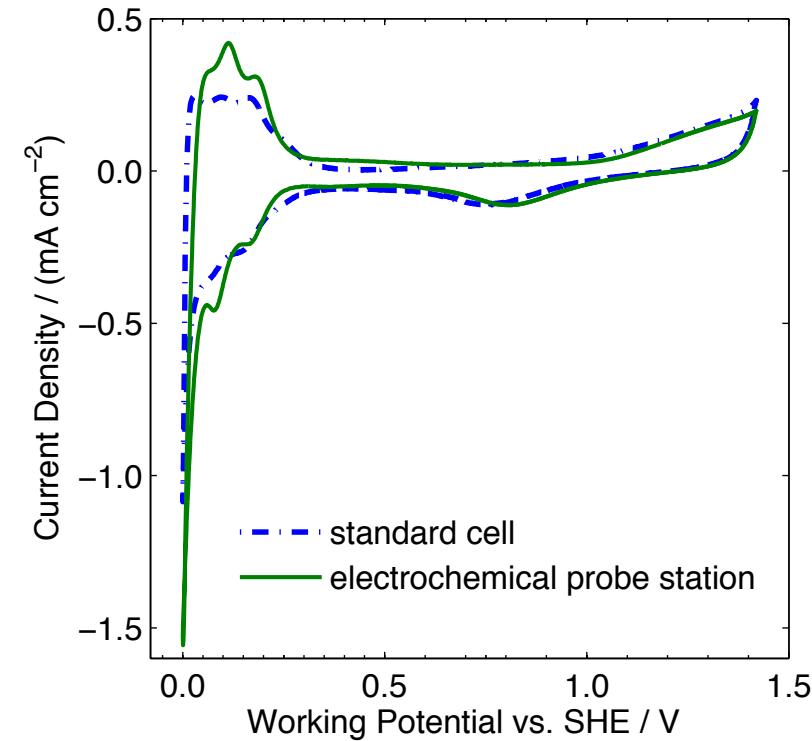
Microdroplet Cell



- LabView-controlled
- Automated droplet positioning, dispensing, testing
- Stage with programmable temperature control
- PTFE needle

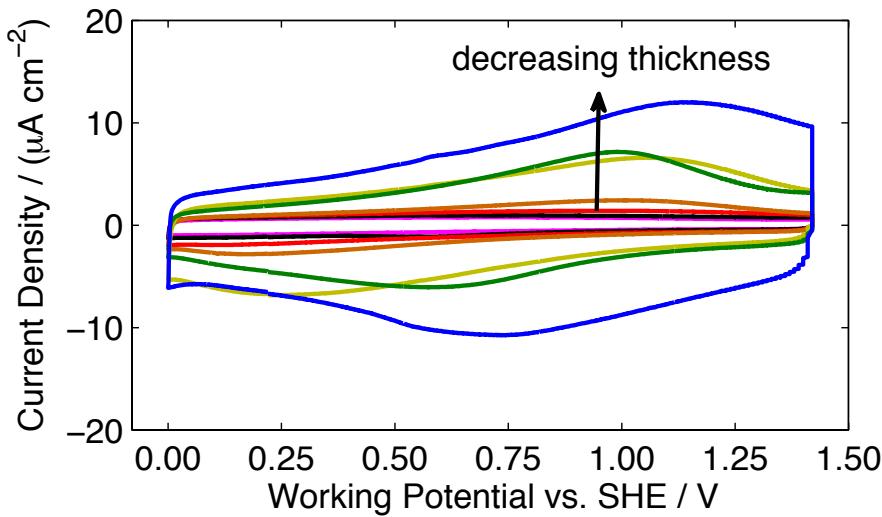


Measurement Automation

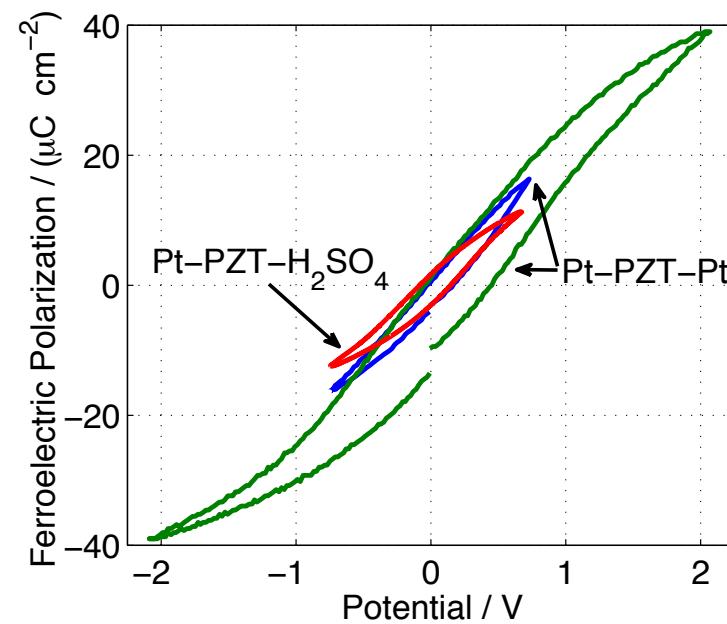


4.0% variability of hydrogen adsorbed onto thin film Pt in 1 N H_2SO_4 . 0.25 mm^2 contact area.

Continuous PZT: Ferroelectric Hysteresis



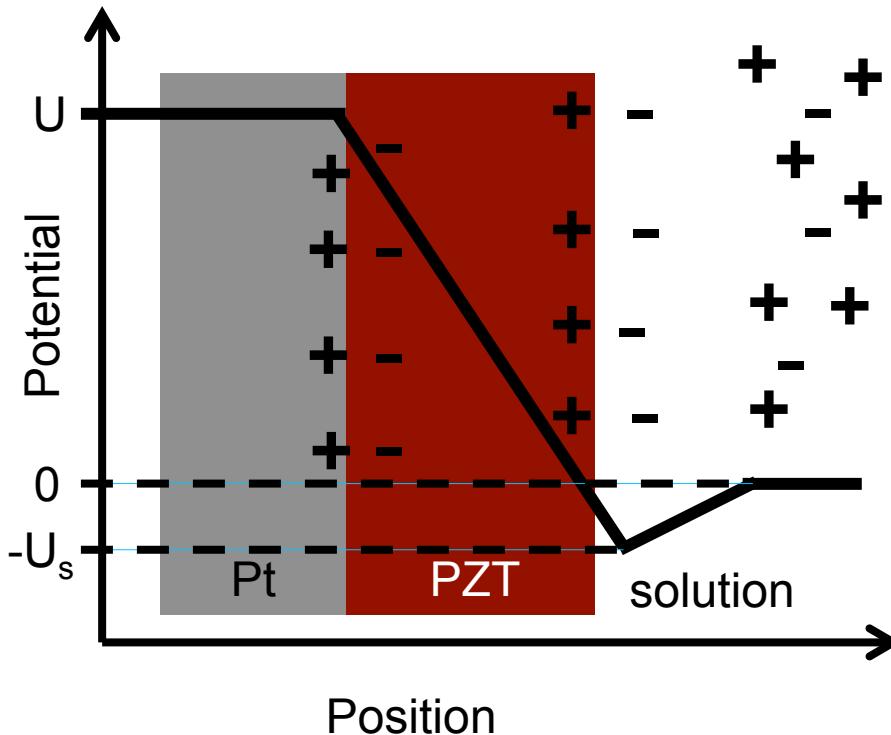
360, 300, 270, 200, 160, 100, 50 nm
 PZT in 1 N H_2SO_4
 100 mV/s



50 nm PZT, 3 Hz, 1 N H_2SO_4

Continuous PZT – Solution Interface

PZT controls the interface!



Ferroelectric surface charge, σ , creates potential difference across PZT-solution interface.

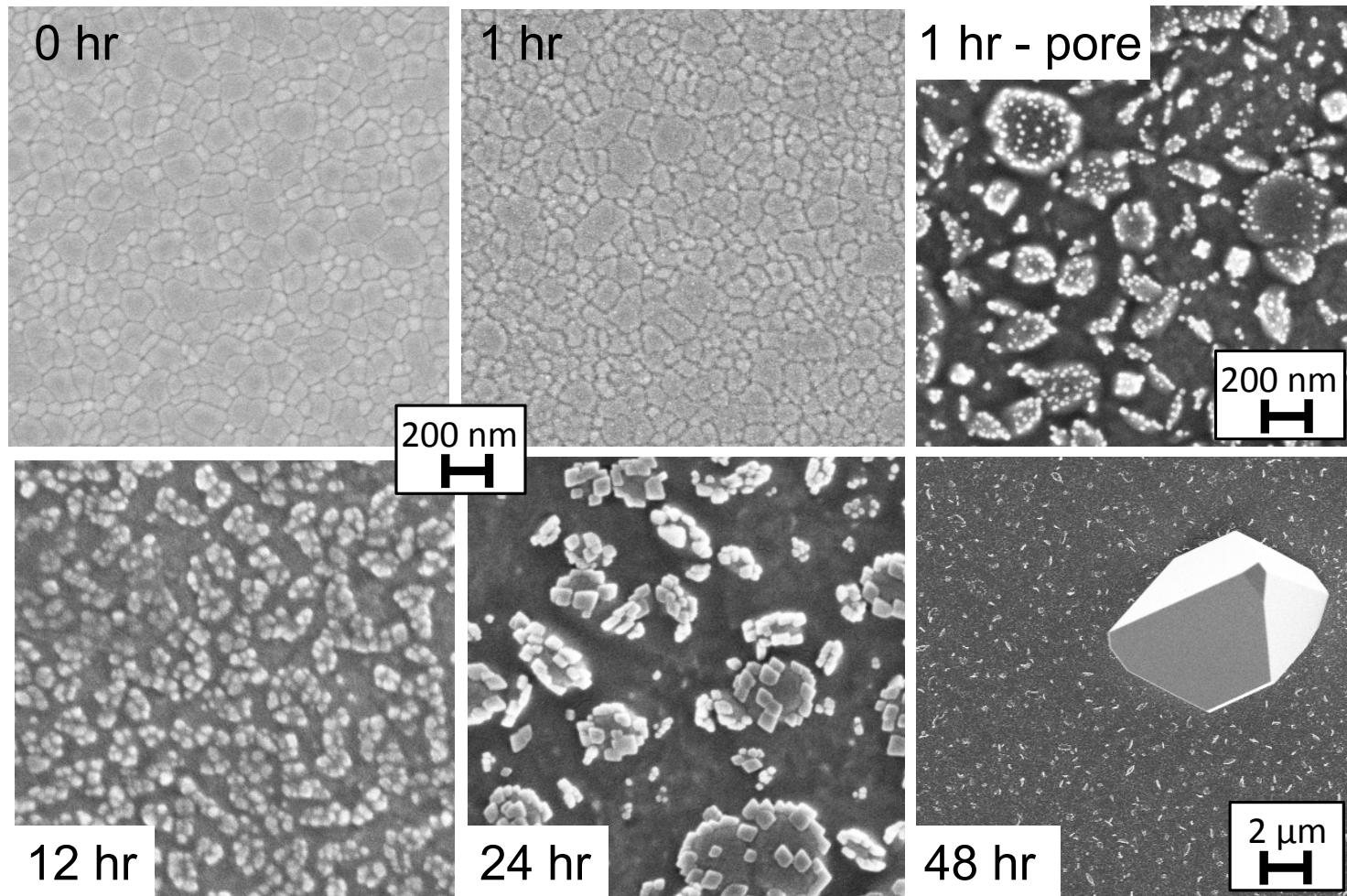
$$U_s = \frac{\sigma \epsilon_{PZT} d}{2 \epsilon_0 \epsilon_{H_2O} (1 + \epsilon_{PZT})}$$

$$U_s \sim 55 \text{ mV for } 20 \mu\text{C/cm}^2$$

$$\epsilon_{H_2O} = 80$$

$$d = 0.4 \text{ nm}$$

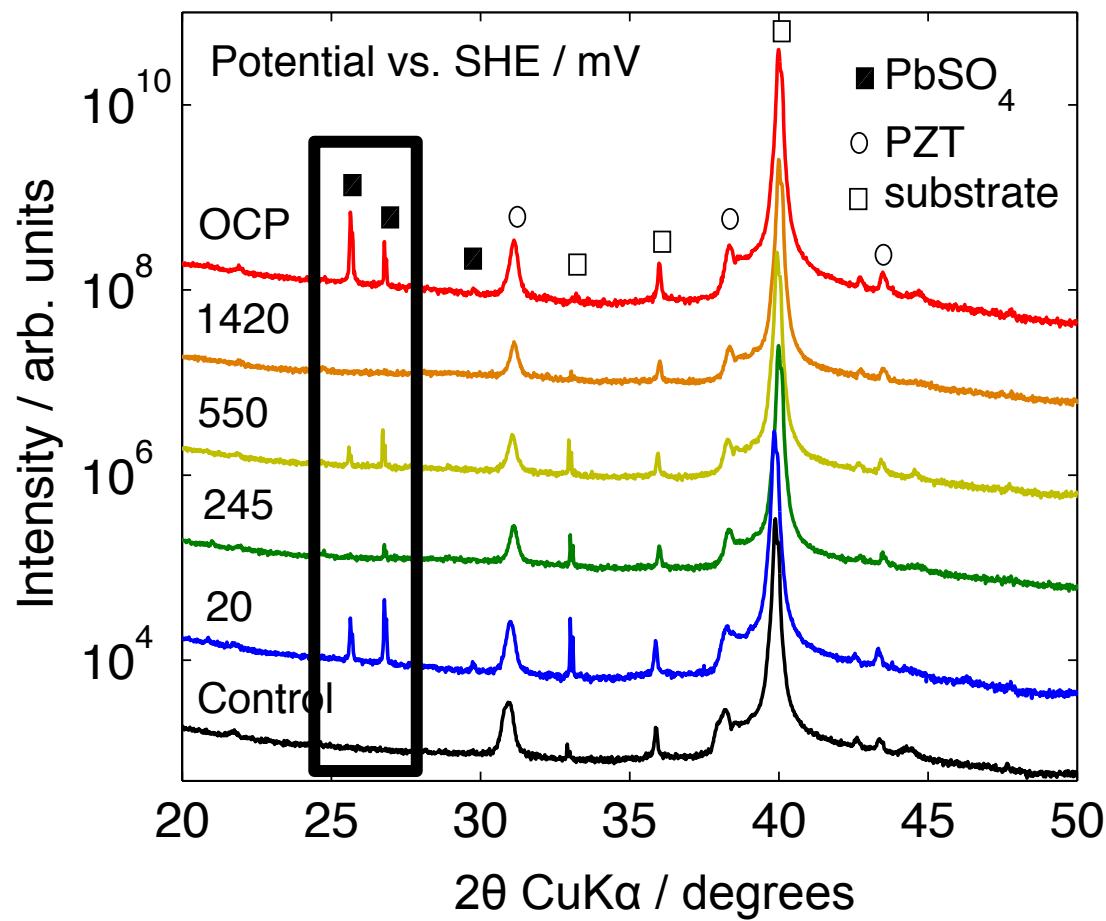
Microstructural Evolution



PZT film held in 0.1 N H_2SO_4 at 550 mV vs. SHE

X-Ray Diffraction at 48 Hours

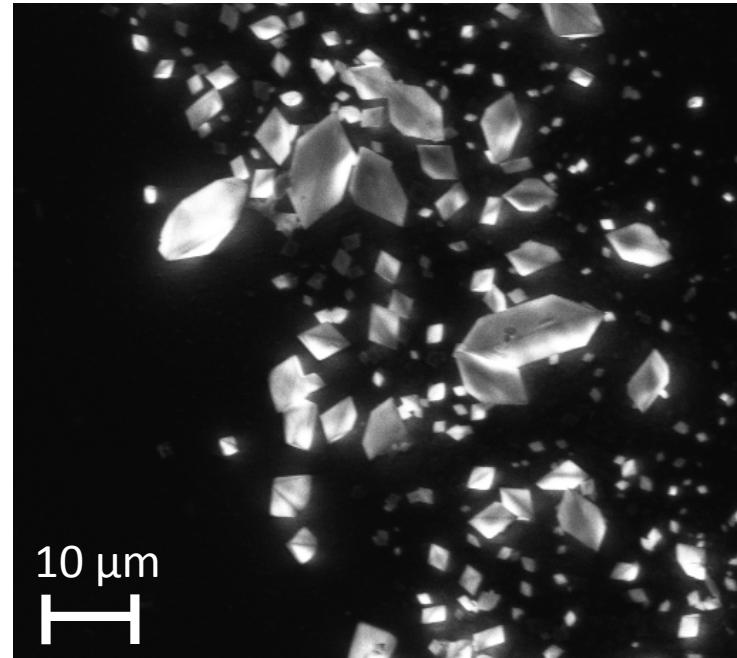
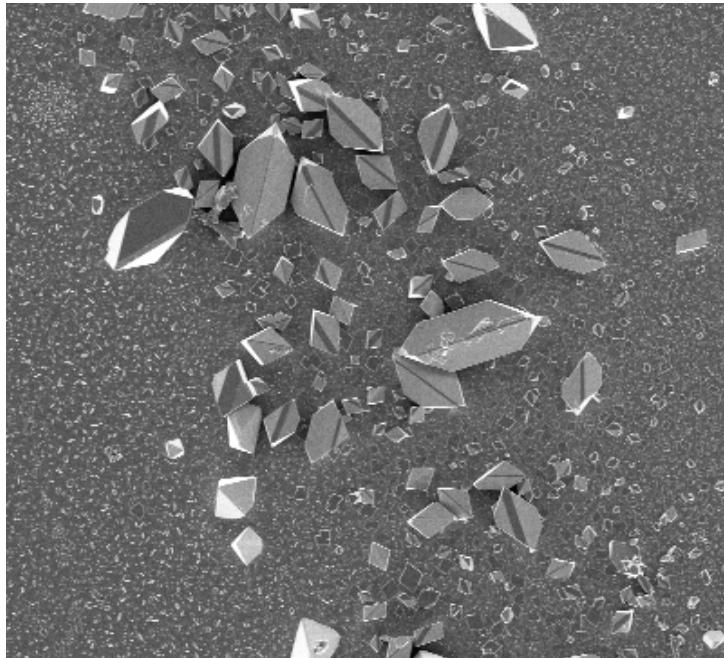
- All 48 hour samples except 1420 mV show crystalline PbSO_4 .
- No other new phases



θ - 2θ scans from PZT held for 48 hours in 0.1 N H_2SO_4 .

PbSO₄ Crystal Formation

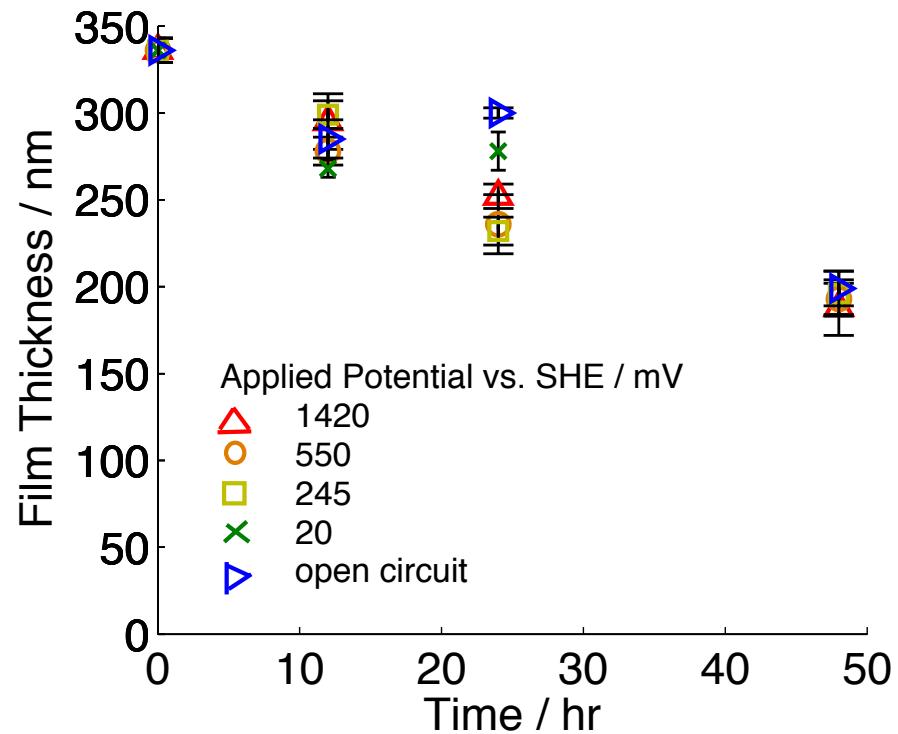
PZT surface after 48 hours in 0.1 N H₂SO₄ at 550 mV vs. SHE



Plan-view SEM micrographs: (left) secondary electron image (right) visible light image.

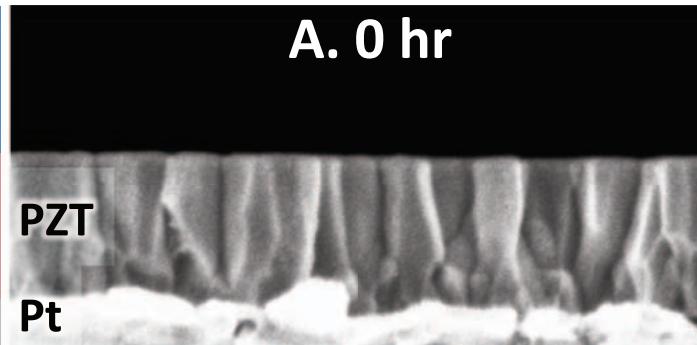
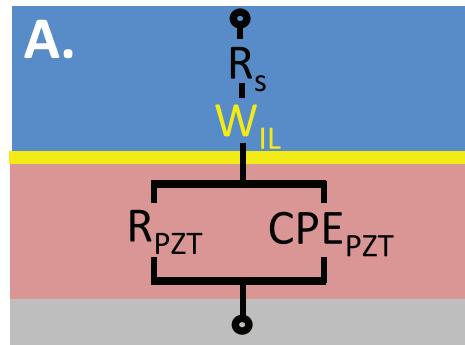
Etch Rate

- Etch rate independent of applied potential
- 2.8 nm/hr average
- No electron transfer process present

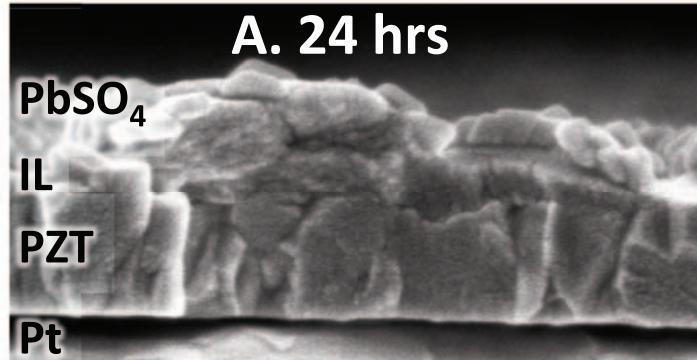
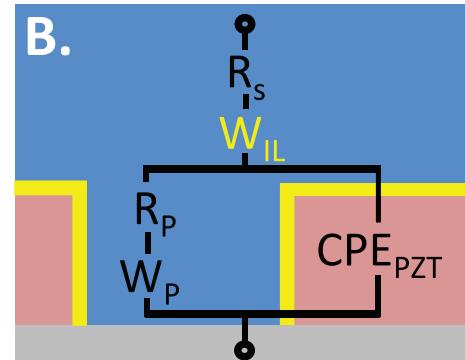


EIS Model Development

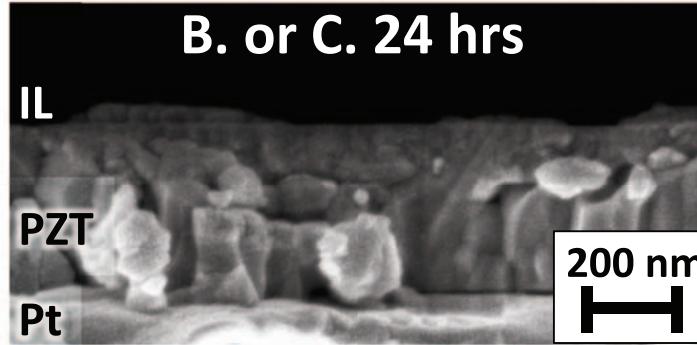
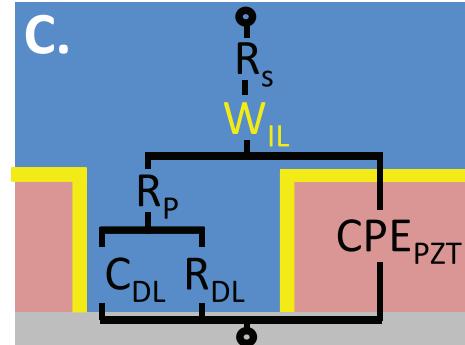
IL Formation



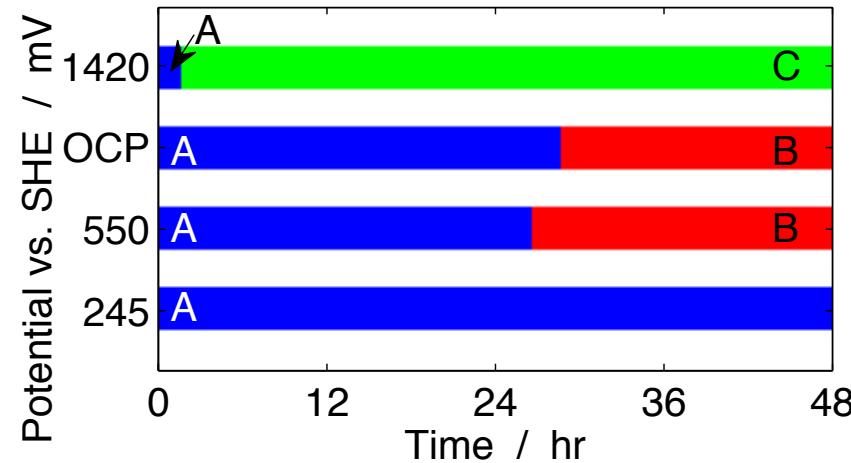
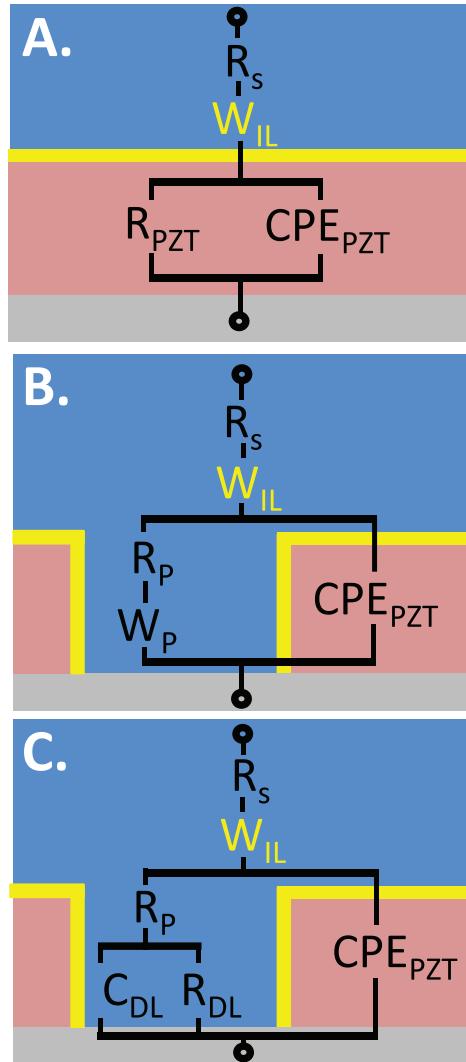
Pore growth



Gas Evolution



EIS of All Samples

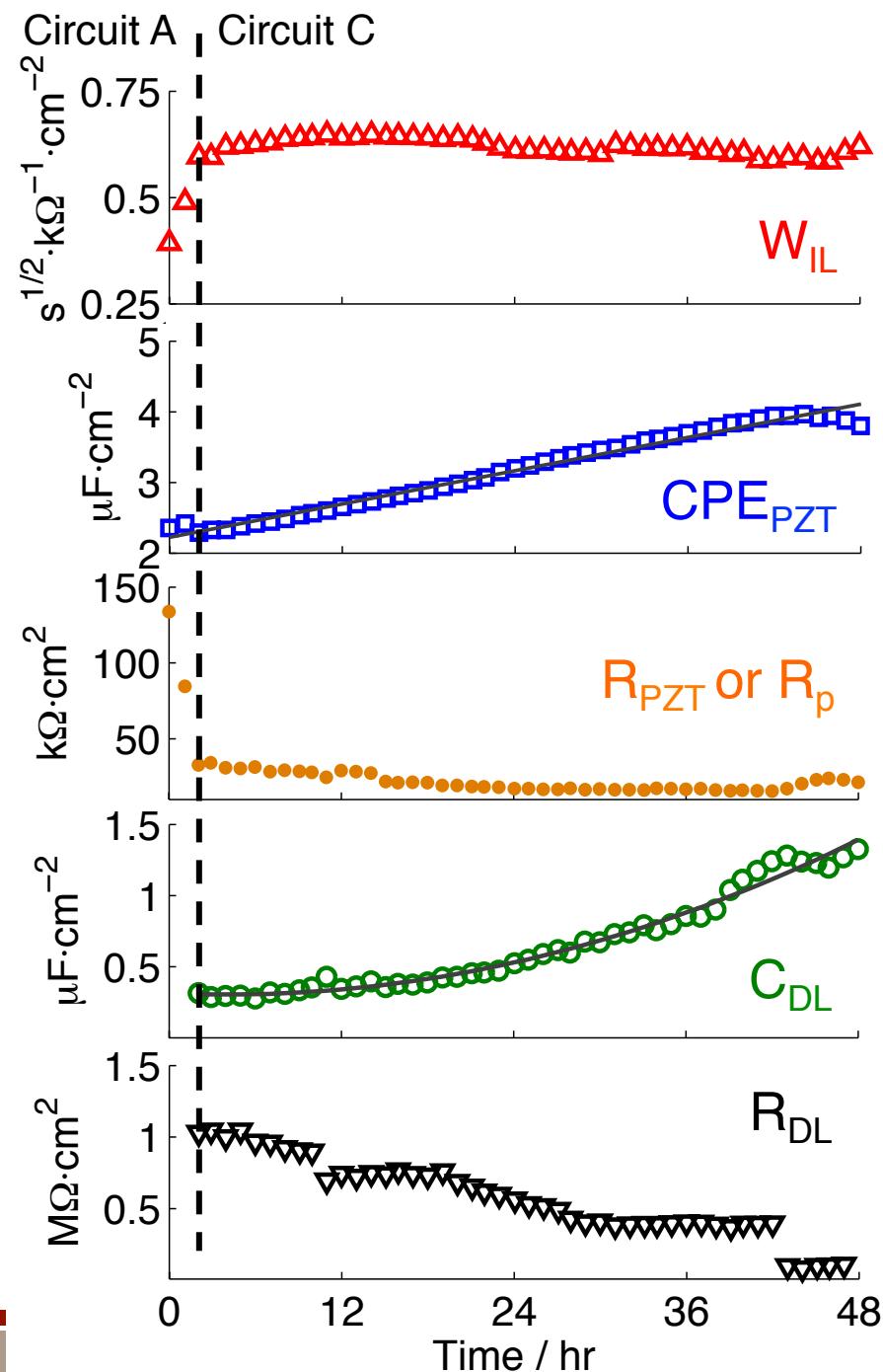
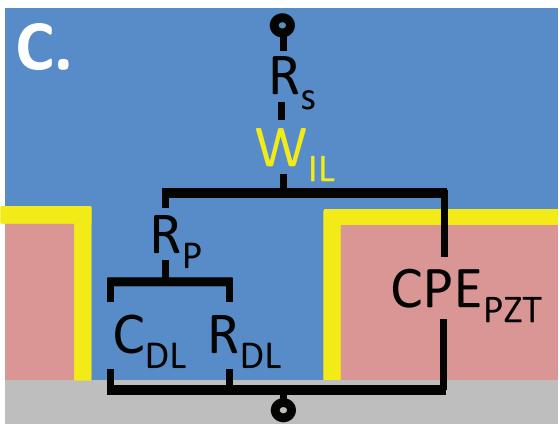


- All start as circuit A – PZT with IL growing
- Circuit B – pore growth, diffusion-limited process in pore
- Circuit C – oxygen evolution at pores/platinum

Circuit Elements vs. Time

1420 mV vs. SHE

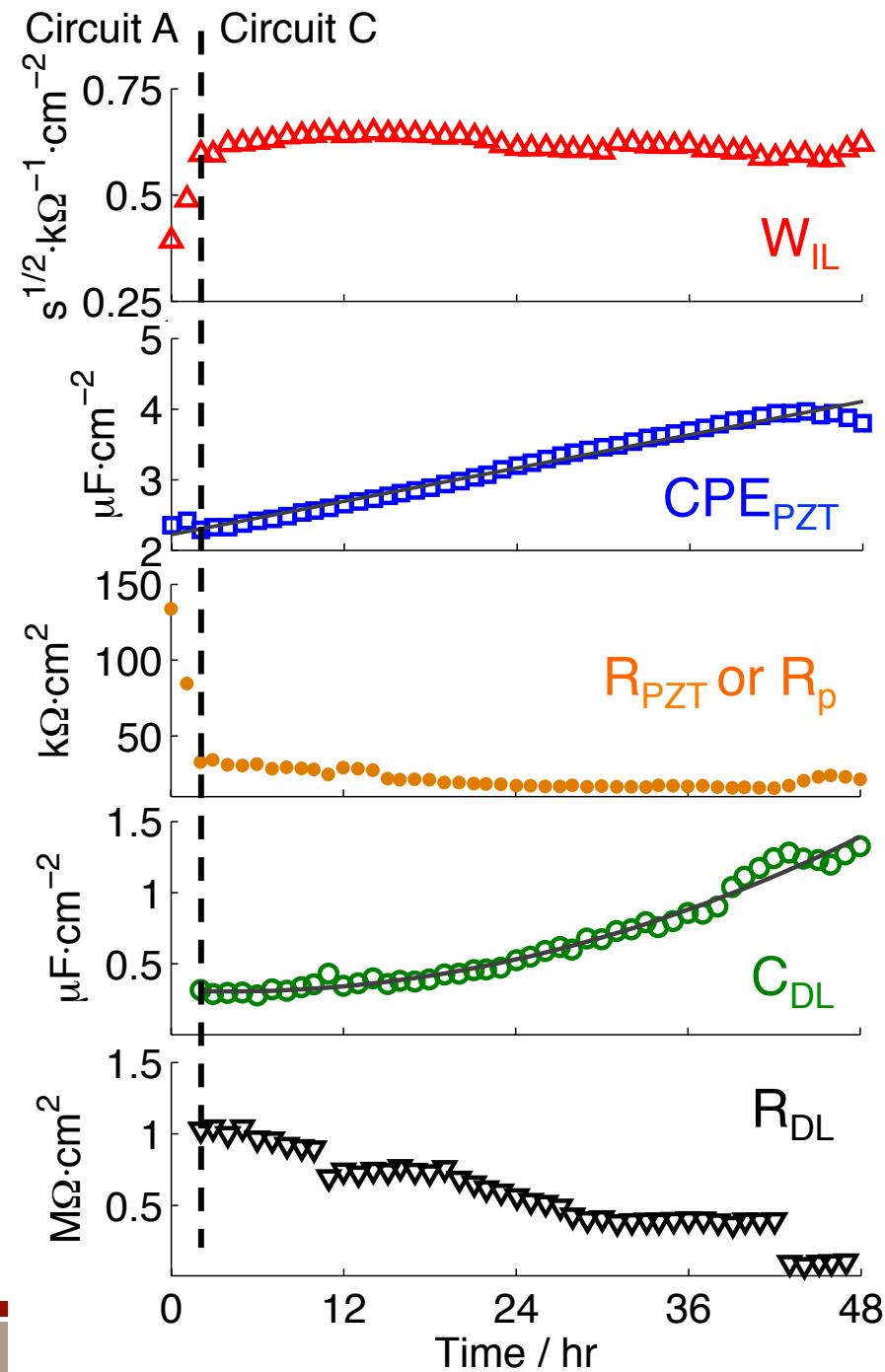
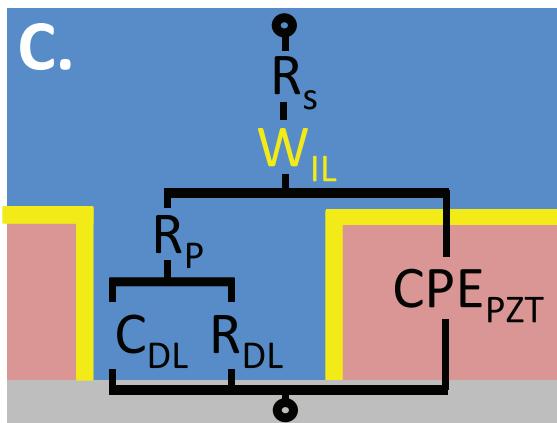
- W_{IL} grows over the first 2 hours, reaches stable value.
- CPE_{PZT} linearly increases with time, as expected for decreasing film thickness.
- R_p decreases with increasing pore size



Circuit Elements vs. Time

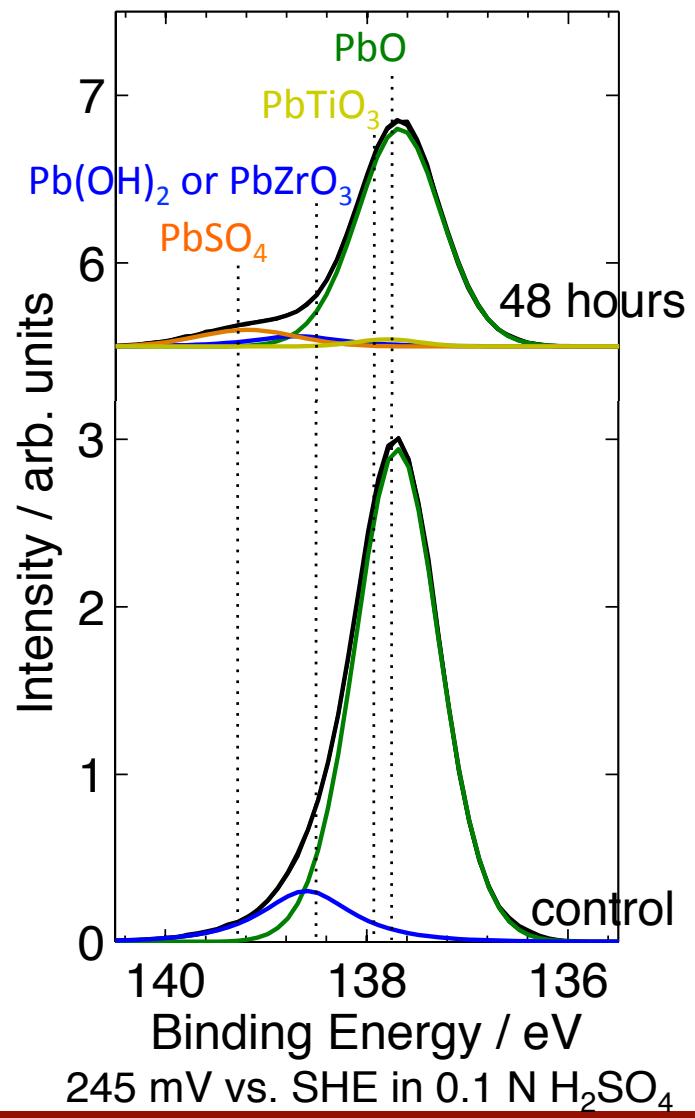
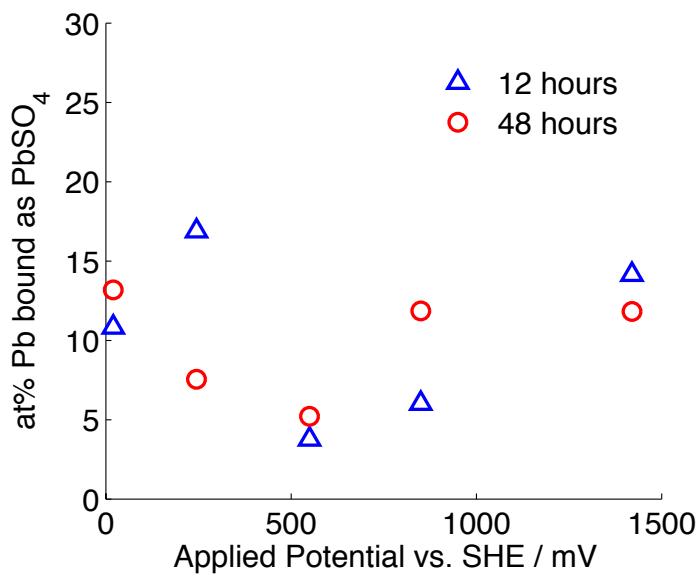
1420 mV vs. SHE

- C_{DL} is proportional to area of platinum exposed through pores.
- Quadratic fit
→ pores etched radially at a nearly constant rate



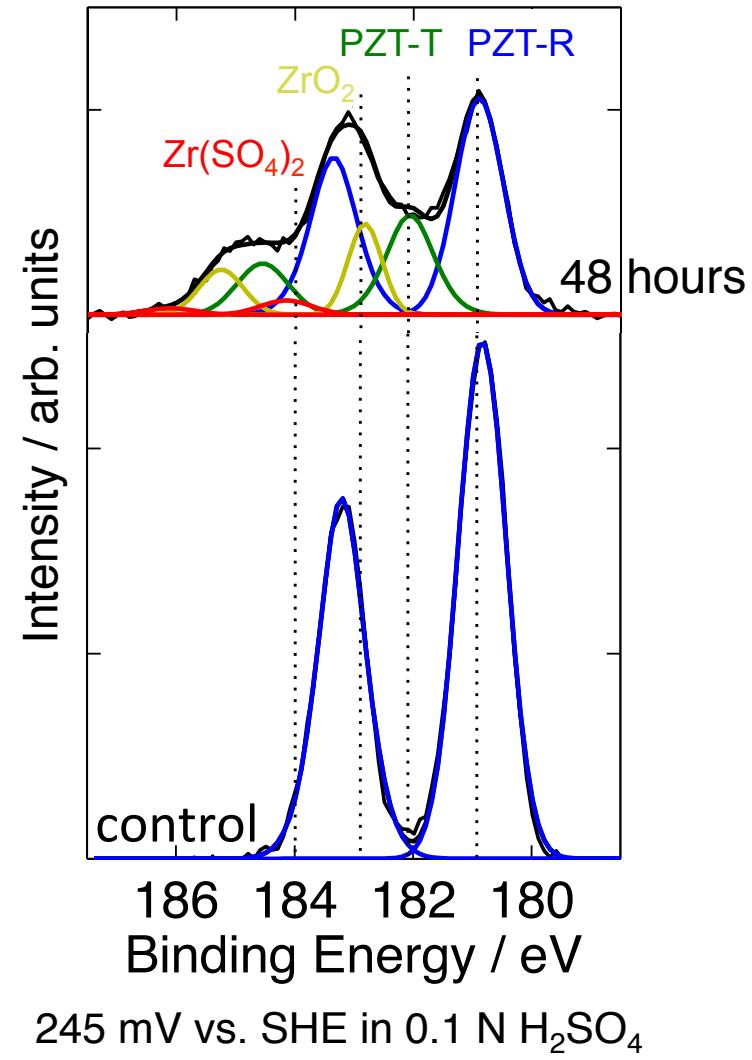
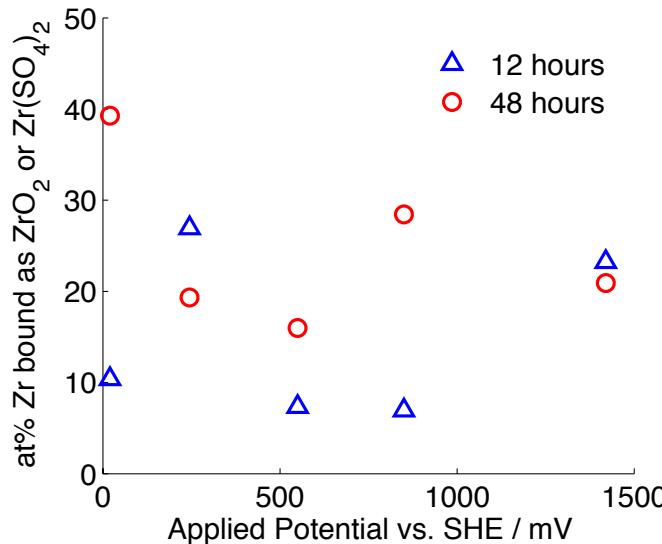
XPS Analysis: Lead 4f_{7/2}

- PbSO₄ present after acid exposure
- at% Pb bound as PbSO₄ not strongly affected by potential or time



XPS Analysis: Zirconium 3d

- Tetragonal and rhombohedral PZT phases identified¹
- SO_4^{2-} interacts with Zr
- at% Zr in sulfate states not affected by time or potential

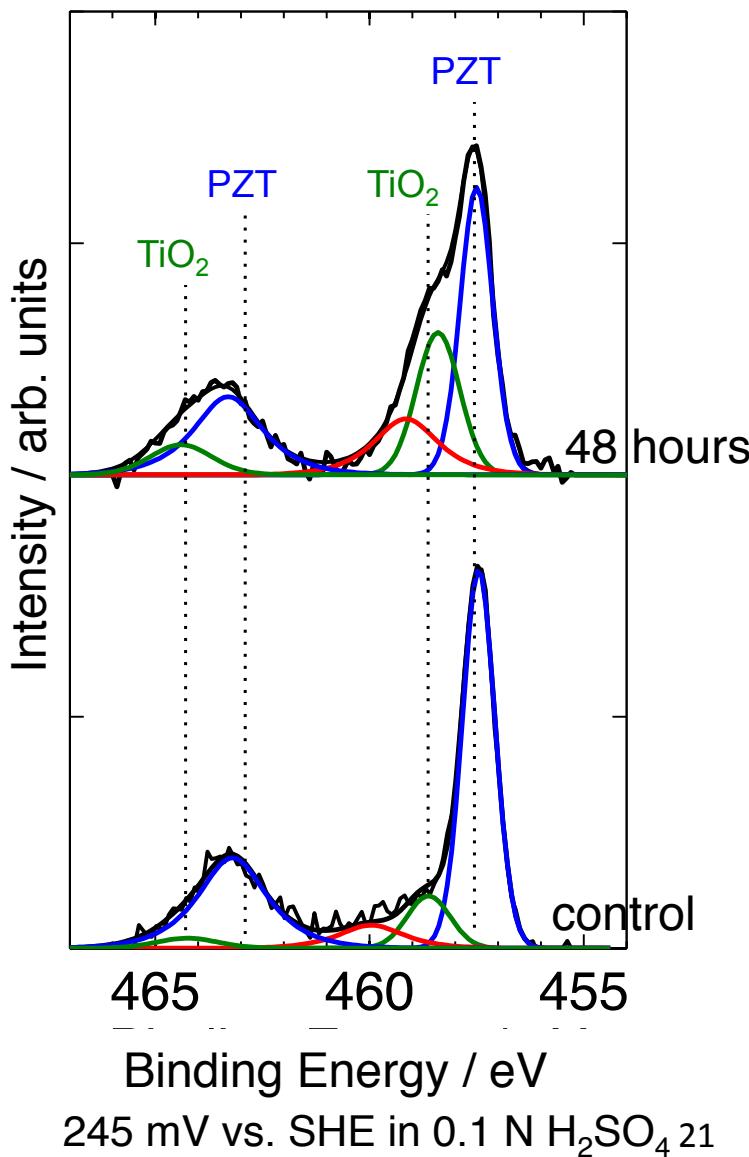
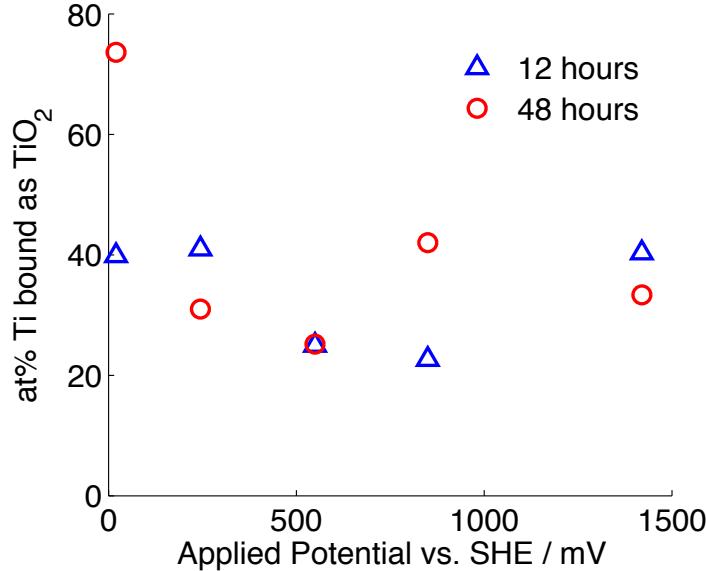


¹O. Sugiyama, K. Murakami, and S. Kaneko, *J. Euro. Ceram. Soc.* **24**, 1157 (2004).

L. Small, M. Brumbach, C. Apblett, J.F. Ihlefeld, G. Brennecke, and D. Duquette, *J. Electrochem. Soc.*, **160** (2013) C128-C135.

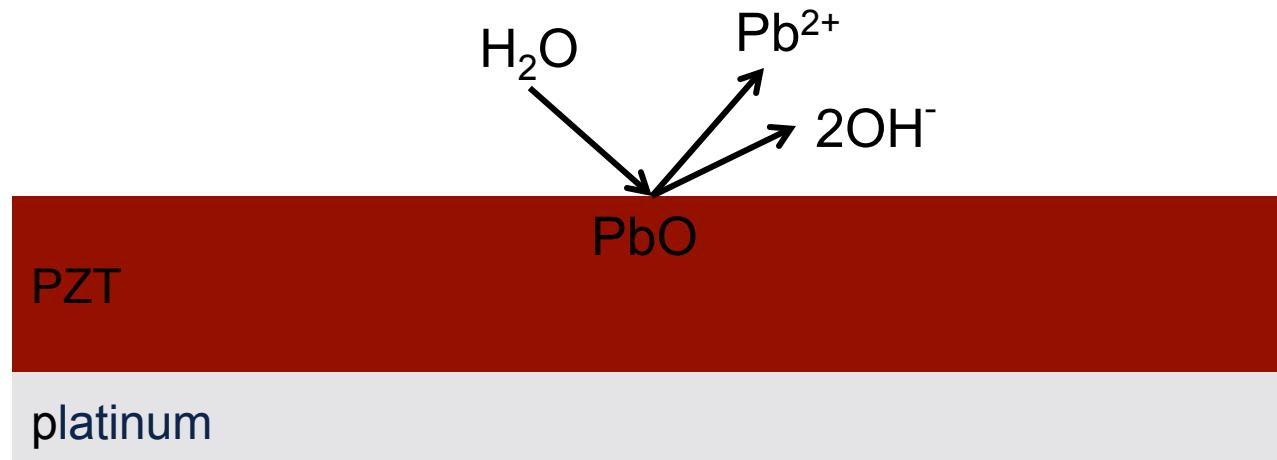
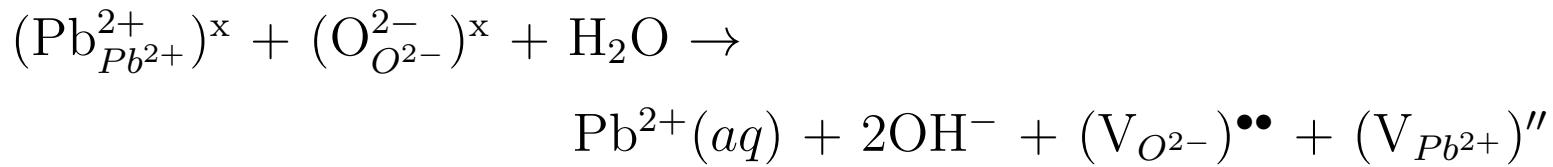
XPS Analysis: Titanium 2p

- No new phases after acid exposure
- at% TiO_2 increases upon acid exposure



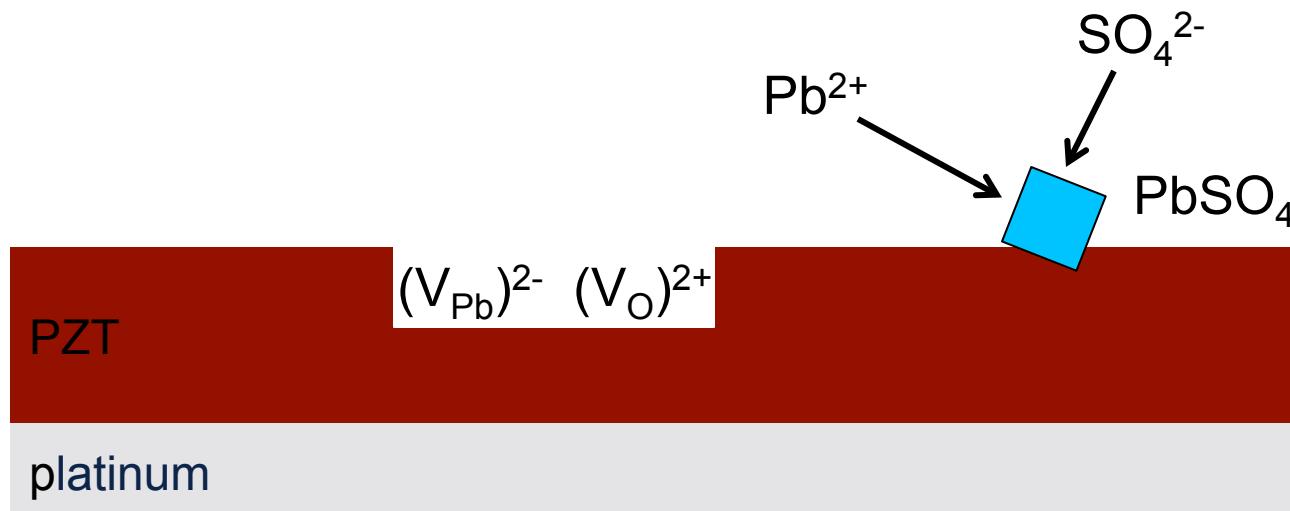
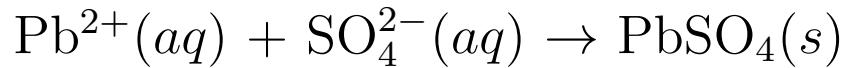
Proposed Dissolution Process

- PbO hydrolysis



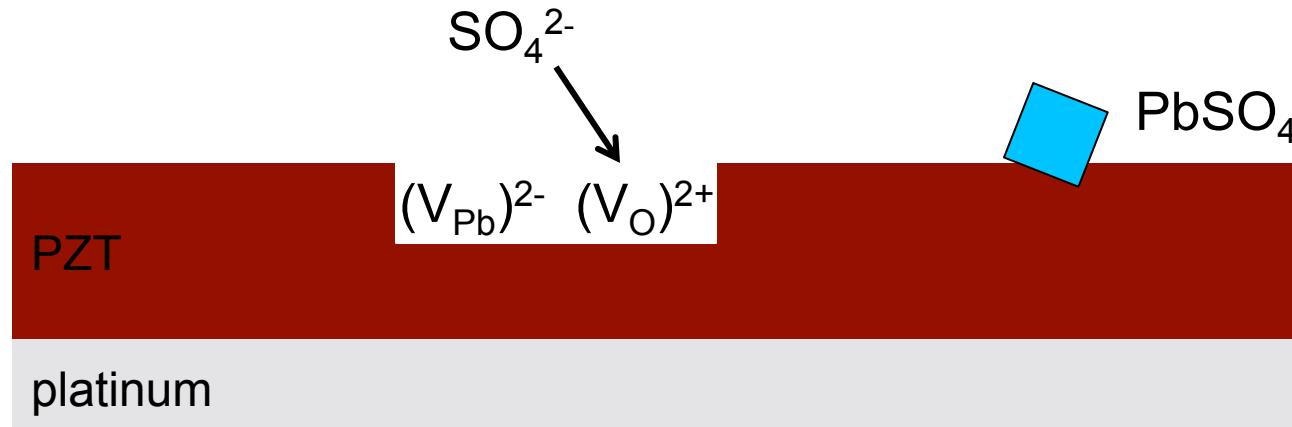
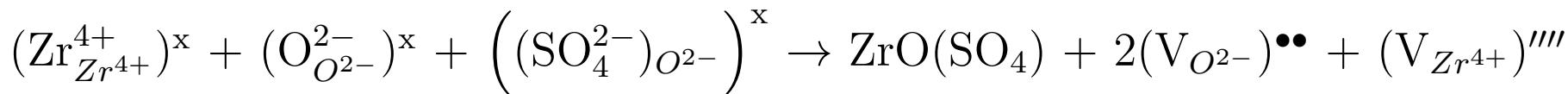
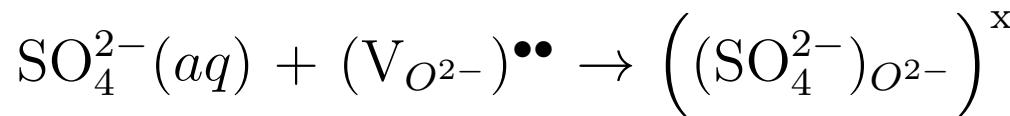
Proposed Dissolution Process

- PbO hydrolysis
- PbSO₄ formation



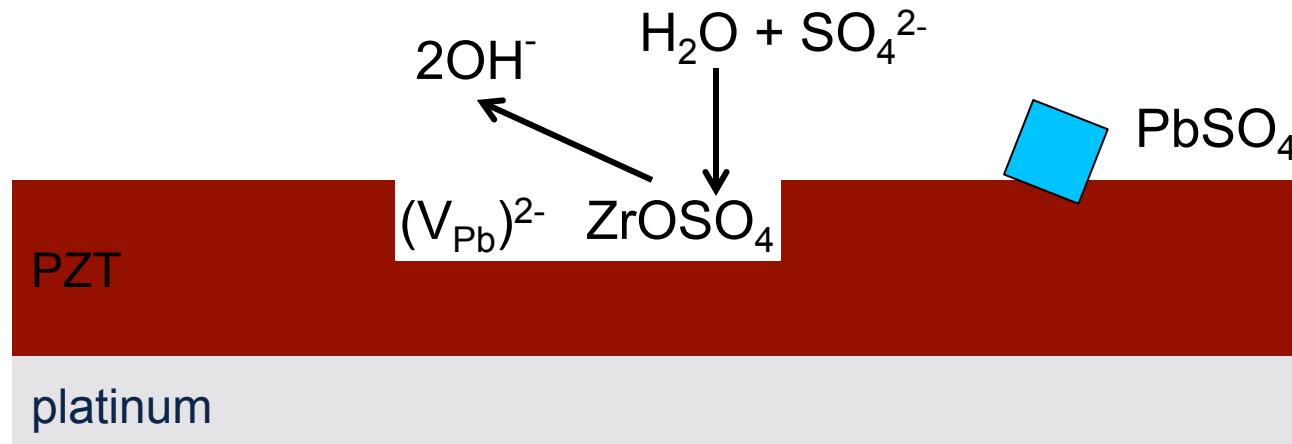
Proposed Dissolution Process

- PbO hydrolysis
- PbSO₄ formation
- SO₄²⁻ attacks oxygen vacancy, bonds with Zr



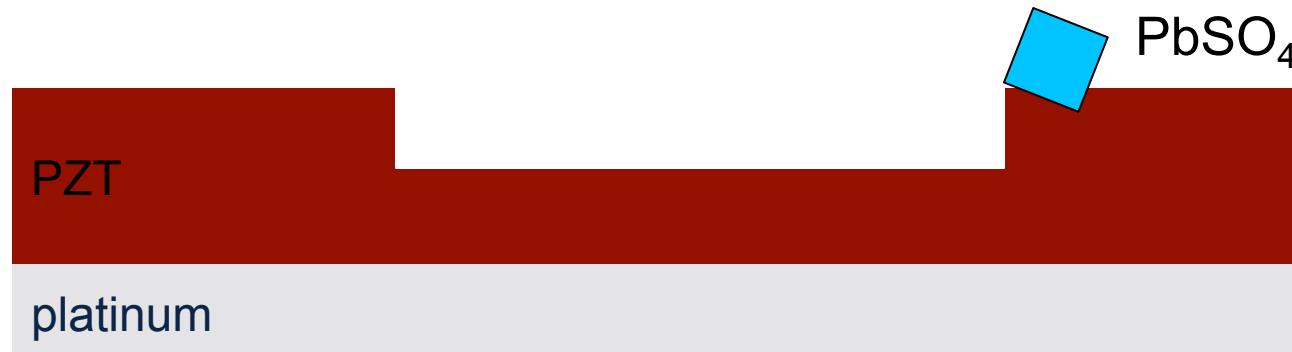
Proposed Dissolution Process

- PbO hydrolysis
- PbSO₄ formation
- SO₄²⁻ attacks oxygen vacancy, bonds with Zr
- Zr(SO₄)₂ formation



Proposed Dissolution Process

- PbO hydrolysis
- PbSO₄ formation
- SO₄²⁻ attacks oxygen vacancy, bonds with Zr
- Zr(SO₄)₂ formation and dissolution
- TiO²⁺ dissolution



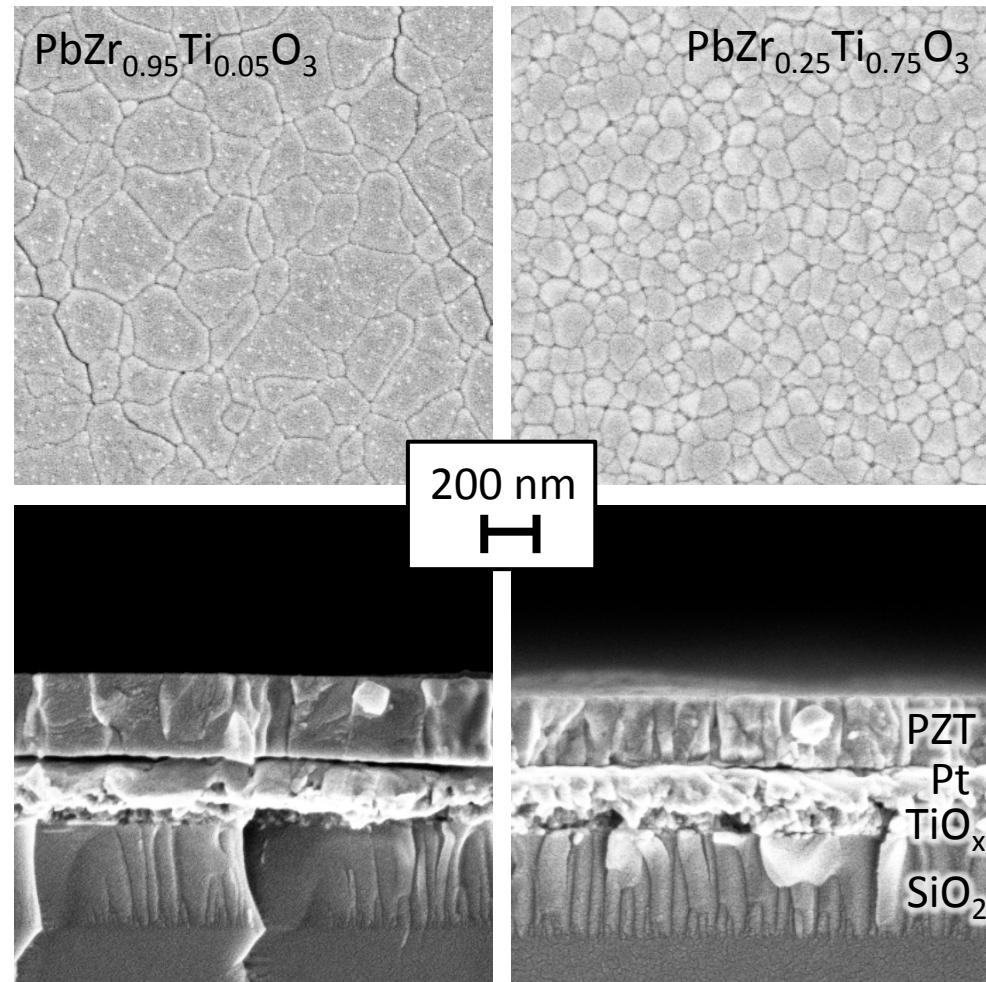
Effect of the Zr/Ti Ratio

Dense, columnar
microstructure
before acid exposure

Film thickness:

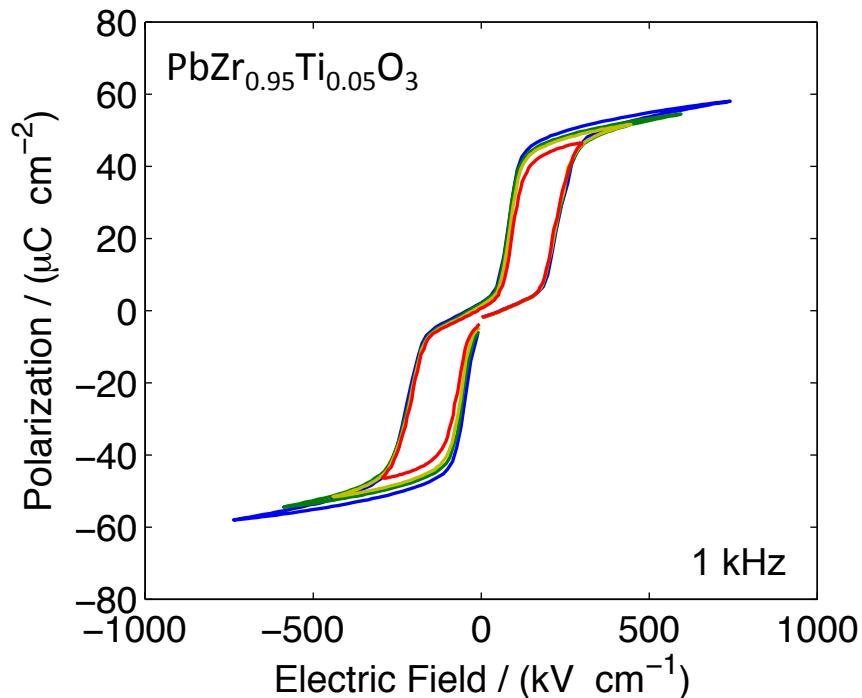
PZT 95/5: 330 nm

PZT 25/75: 250 nm

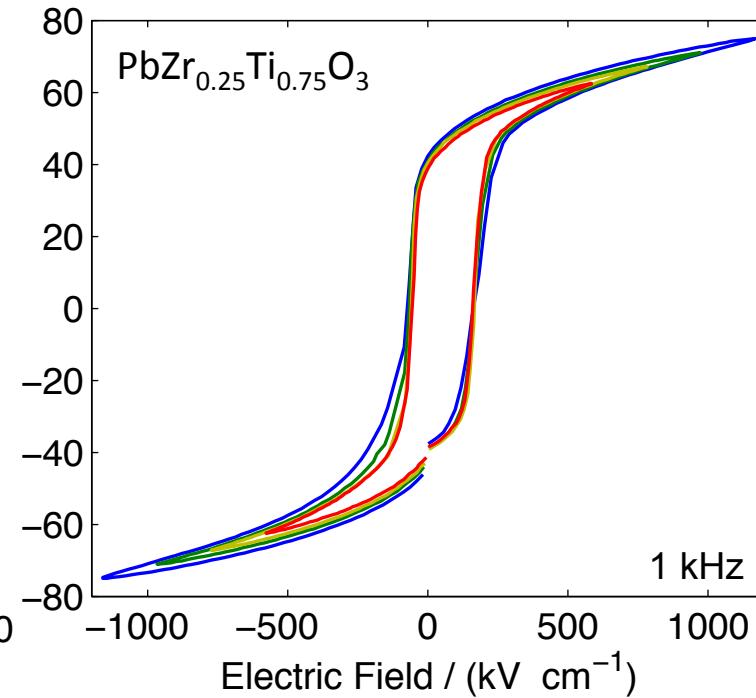


Effect of the Zr/Ti Ratio II

Verify electronic electronic properties – very good!



$\epsilon_r = 329 \pm 18$
 $\tan\delta = 0.012 \pm 0.001$
 1 kHz, 25 mV RMS, 0 VDC

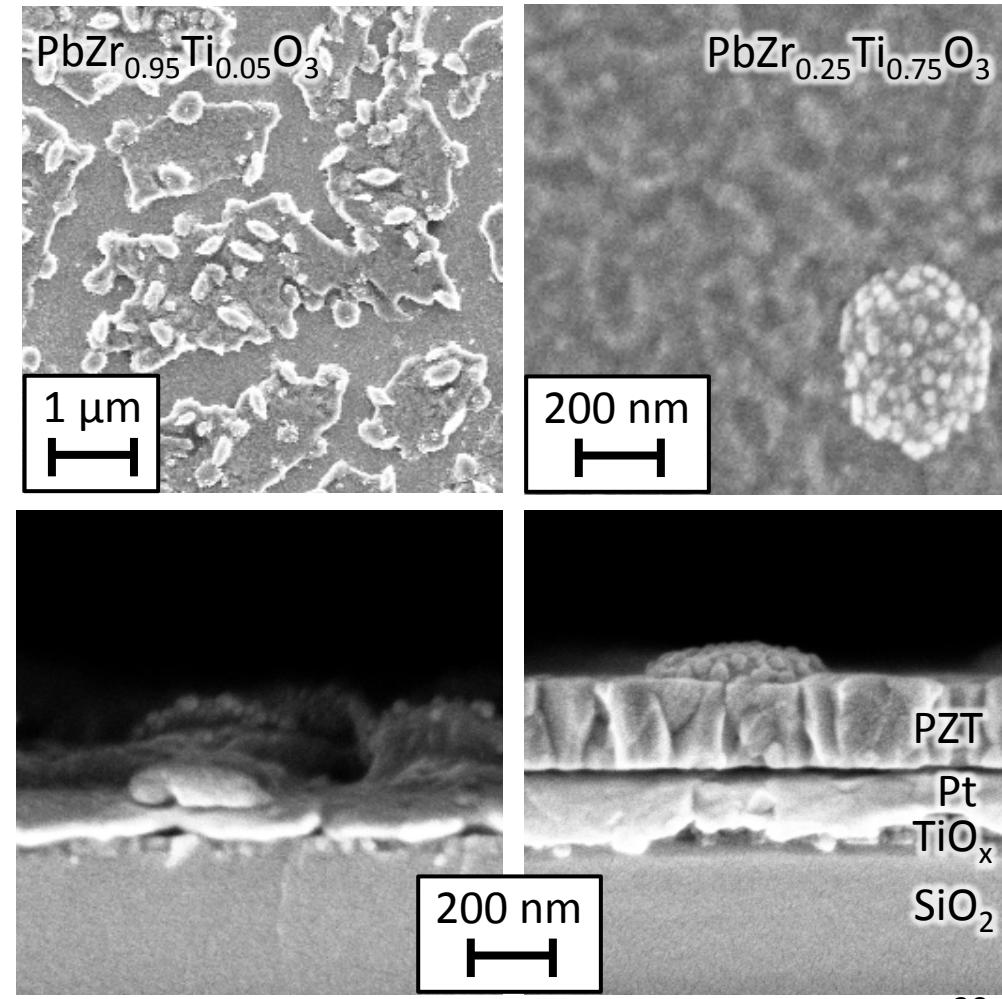


$\epsilon_r = 682 \pm 36$
 $\tan\delta = 0.018 \pm 0.001$

Effect of the Zr/Ti Ratio II

After 48 hours in 0.1 N
 H_2SO_4 at 550 mV vs. SHE

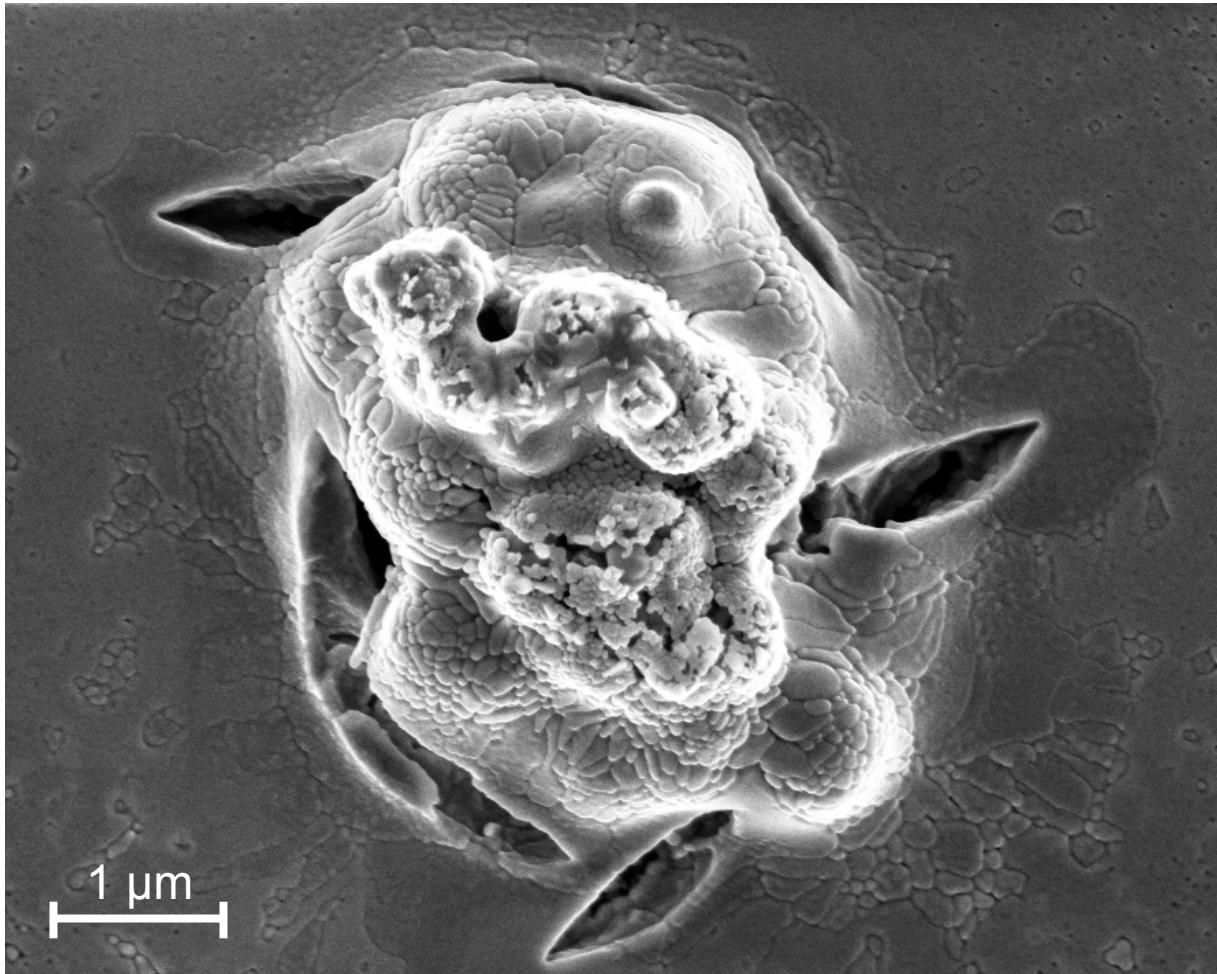
- Film thickness:
 - PZT 95/5: ~0
 - PZT 25/75: 220 nm
- **Increased Ti content reduces etch rate:**
 - PZT 95/5: 11 nm/hr
 - PZT 52/48: 2.8 nm/hr
 - PZT 25/75: 0.56 nm/hr



Summary

- PZT in sulfuric acid = bad choice
- Built a fully automated microdroplet cell
- First thin film PZT ferroelectric hysteresis with liquid contact
- Used EIS, XRD, XPS, SEM to create PZT dissolution model
- Increased Ti content = reduced etch rate in H_2SO_4

Questions?



The epitaxy monster ruins a perfectly good epitaxial PZT film on $\text{SrRuO}_3/\text{SrTiO}_3$ (001).